PT4410 Series



100-Watt 48-V Input **Isolated DC/DC Converter**



Features

- Input Voltage Range: 36 V to 75 V
- Programmable Output Voltage
- +90 % Efficiency
- 1500 VDC Isolation
- On/Off Control
- **Over-Current Protection**
- Differential Remote Sense

Case/Pin

Vertical

SMD

Horizontal

Configuration

- Output Over-Voltage Protection
 IPC Lead Free 2

Ordering Information

PT4411 = 1.3 to 3.5 Volts

PT4412□ = 1.05 to 1.75 Volts

PT4413 = 3.4 to 5.7 Volts

PT Series Suffix (PT1234x)

the dimensions and PC layout)

- Undervoltage Lockout
- Low Profile Package (12mm) • Compact Footprint Comparable to ¹/₄-Brick: (Horiz Config. 1.45 in \times 2.6 in, Vertical Config. < 1 in²)

SLTS170C - JULY 2002 - REVISED JUNE 2003

- Surface Mountable
- Agency Approvals: UL 60950, CSA 22.2 950

Package

(ENM)

(ENN)

(ENP)

Code

Order

Suffix

Ν

A

С

(Reference the applicable package code drawing for

Over-Temperature Shutdown

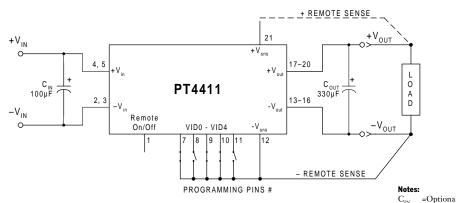
Description

The PT4410 series of power modules are singleoutput isolated DC/DC converters, housed in a compact 21-pin low-profile (12 mm) package. These modules are rated up to 100W with load currents as high as 30 A. The output voltage is set within a pre-defined range via a 5-bit input code.

The PT4410 series operates from a standard 48-V telecom CO supply and occupies only 3.9 in² of PCB area. These modules offer OEMs a compact and flexible high-output power source for use with high-end microprocessors, DSPs, general purpose logic and analog. They are suitable for distributed power applications in both telecom and computing environments.

Features include output over-current protection, on/off control, output over-voltage protection (OVP), over-temperature shutdown, under-voltage lockout (UVLO), and an output differential remote sense. The modules are fully integrated for stand-alone operation, and require no additional components. The horizontal package outline is also comparable to industry standard ¼-bricks, allowing for a dual PWB layout.

Standard Application



=Optional 100 µF electroliytic capacitor C_{OUT} =Optional 330 µF electrolytic capacitor # VID programming pins are set for 3.3 V output



Pin	Function
1	Remote On/Off*
2	-V _{in}
3	-V _{in}
4	+Vin
5	+Vin
6	Pin Not Present
7	VID 0
8	VID 1
9	VID 2
10	VID 3
11	VID 4 †
12	(-)Remote Sense
13	-Vo
14	-V _o
15	-Vo
16	-Vo
17	+V _o
18	+V ₀
19	+V _o
20	+V ₀
21	(+)Remote Sense
* For 1	nore information consult

the applicable application note.

† VID 4 does not function on the PT4412 & PT4413



For technical support and more information, see inside back cover or visit www.ti.com

Environmental Specifications

Characteristics	Symbols Conditions				Max	Units
Operating Temperature Range	Ta	Over Vin Range	-40	_	+85 (i)	°C
ShutdownTemperature	OTP	Case temperature - auto reset	_	115	—	°C
Solder Reflow Temperature	T _{reflow}	Surface temperature of module pins or case		_	215 (ii)	°C
Storage Temperature	Ts	—	-40	_	+125	°C
Mechanical Shock		Per Mil-STD-883D, Method 2002.3 1 msec, ½ Sine, mounted	_	500	_	G's
Mechanical Vibration		Mil-STD-883D, Method 2007.2 Vertical 20-2000 Hz, PCB mounted Horizontal	_	15 (iii) 20 (iii)	_	G's
Weight	_	Vertical/Horizontal	_	50	_	grams
Flammability	_	Meets UL 94V-O				

Notes (i) See SOA curves or consult factory for appropriate derating

(ii) During solder reflow of SMD package version, do not elevate the module case, pins, or internal component temperatures above a peak of 215 °C. For further guidance refer to the application note, "Reflow Soldering Requirements for Plug-in Power Surface Mount Products," (SLTA051).
 (iii) The case pins on the through-hole package types (suffixes N &A) must be soldered. For more information see the applicable package outline drawing.

Output Voltage Programming Information

				PT4 4	411	PT4412	PT4413
VID3	VID2	VID1	VIDO	VID4=1 Vout	VID4=0 Vout	VID4= NC Vout	VID4= NC Vout
1	1	1	1	N/D *	1.30 V	N/D *	N/D *
1	1	1	0	2.10 V	1.35 V	1.05 V	3.40 V
1	1	0	1	2.20 V	1.40 V	$1.10 \mathrm{V}$	3.56 V
1	1	0	0	2.30 V	1.45 V	1.15 V	3.72 V
1	0	1	1	2.40 V	1.50 V	1.20 V	3.88 V
1	0	1	0	2.50 V	1.55 V	1.25 V	4.05 V
1	0	0	1	2.60 V	1.60 V	1.30 V	4.21 V
1	0	0	0	$2.70 \mathrm{V}$	1.65 V	1.35 V	4.37 V
0	1	1	1	2.80 V	$1.70\mathrm{V}$	1.40 V	4.53 V
0	1	1	0	2.90 V	1.75 V	1.45 V	4.69 V
0	1	0	1	3.00 V	$1.80\mathrm{V}$	1.50 V	4.86 V
0	1	0	0	3.10 V	1.85 V	1.55 V	5.02 V
0	0	1	1	3.20 V	1.90 V	1.60 V	5.18 V
0	0	1	0	3.30 V	1.95 V	1.65 V	5.34 V
0	0	0	1	3.40 V	2.00 V	$1.70 \mathrm{V}$	5.50 V
0	0	0	0	3.50 V	2.05 V	1.75 V	5.67 V

Logic 0 =Pin 12 potential; (–)Remote Sense Logic 1 =Open circuit (no pull-up resistors) * N/D = Voltage is not defined. The regulator produces a low-voltage periodic pulse (less than 1 V) approximately every 10 ms.

<u>Note</u>: During operation, changes to the program code should be limited to 15 % of V_0 so as to avoid activating the output O V protection.

Pin Descriptions

+Vin: The positive input for the module with respect to $-V_{in}$. When powering the module from a -48-V telecom central office supply, this input is connected to the primary system ground.

-Vin: The negative input supply for the module, and the 0 VDC reference for the Remote On/Off input. When powering the module from a +48-V supply, this input is connected to the 48-V(Return).

Remote On/Off: An open-collector (open-drain) positive logic input that is referenced to $-V_{in}$. Pulling this input down to $-V_{in}$ potential disables the module's output. If this input is left open-circuit, the module will produce an output whenever a valid input source is applied.

VID0 – VID4: Selects the set-point output voltage of the converter according to the applicable program code. VID0 – VID4 must either be connected to (–)Remote Sense or left open circuit. *Note: For the PT4412, VID 4 is internally disabled and may be left open circuit.*

+Vo: The positive power output with respect to $-V_o$, which is DC isolated from the input supply pins. If a negative output voltage is desired, $+V_o$ should be connected to the secondary circuit common and the output taken from $-V_o$.

-Vo: The negative power output with respect to $+V_o$, which is DC isolated from the input supply pins. This output is normally connected to the secondary circuit common when a positive output voltage is desired.

+Remote Sense: Provides the converter with remote sense capability to regulate the set-point voltage directly at the load. When used with –Remote Sense, the regulation circuitry will compensate for voltage drop between the converter and the load. The pin may be left open circuit, but connecting it to $+V_0$ will improve load regulation.

–Remote Sense: This is the logic '0' reference for the inputs VID0 – VID4, and provides the converter with remote sense capability when used in conjunction with +Remote Sense. For optimum output voltage accuracy this pin should always be connected to $-V_0$.

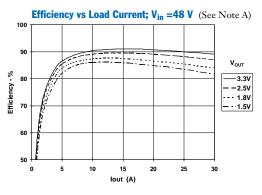
			PT4411				
Characteristic	Symbol Conditions		Min	Тур	Max	Units	
Output Current	Io	Over V _{in} range	0	-	30	А	
Input Voltage Range	Vin	Over I _o Range	36	48	75	\mathbf{V}	
Set Point Voltage Tolerance	Votol			±0.6 (1)	_	%Vo	
Temperature Variation	Reg _{temp}	$-40^{\circ} > T_a > +85 \text{ °C}$		±0.8	_	%Vo	
Line Regulation	Regline	Over Vin range	_	±1	_	mV	
Load Regulation	Regload	Over Io range		±1	_	mV	
Total Output Voltage Variation	ΔV_{0} tot	Includes set-point, line, load, -40° >T _a > +85 °C	_	±1.6	±3	%Vo	
Efficiency	η	I ₀ =15 A		91	_	%	
Vo Ripple (pk-pk)	Vr	20 MHz bandwidth	_	50	_	mVpp	
Transient Response	t _{tr}	1 A/µs load step, 50 % to 100 % I₀max	_	75	_	μs	
	ΔV_{tr}	V _o over/undershoot		±5	_	%Vo	
Over-Current Threshold	I _{TRIP}	Shutdown, followed by auto-recovery		36	_	А	
Output Over-Voltage Protection	OVP	Output shutdown and latch off		125	_	%Vo	
Switching Frequency	$f_{ m o}$	Over Vin range	250	300	350	kHz	
Under-Voltage Lockout	UVLO			32	_	V	
Remote On/Off Input Input High Voltage Input Low Voltage	V _{IIH} V _{IL}	Referenced to -Vin	4.5 -0.2	_	Open (2) +0.8	V	
Input Low Current	I _{IL}			-0.3		mA	
Standby Input Current	I _{in} standby	pins 1 & 2 connected		2	_	mA	
Internal Input Capacitance	Cin			1.4	_	μF	
External Output Capacitance	Cout	Between +Vo and -Vo	0		5,000	μF	
Isolation Voltage Capacitance Resistance		Input-output & input-case Input-output Input-output	$\frac{1500}{10}$	1200		Vdc pF MΩ	

PT4411 Specifications (Unless otherwise stated, $T_a = 25 \text{ °C}$, $V_{in} = 48 \text{ V}$, $V_o = 3.3 \text{ V}$, $C_o = 0 \mu\text{F}$, and $I_o = I_o \text{max}$)

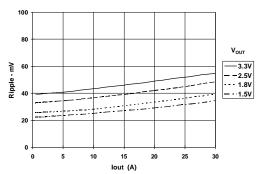
Notes: (1) If (-)Remote Sense is not used, pin 12 must be connected to pin 13 for optimum output voltage accuracy.

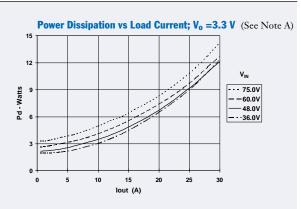
(2) The Remote On/Off input has an internal pull-up. If it is left open-circuit the module will operate when input power is applied. A discrete MOSFET or bipolar transistor is recommended to control this input. The open-circuit voltage is typically 5 V. See application notes for interface considerations.

PT4411 Characterstic Data

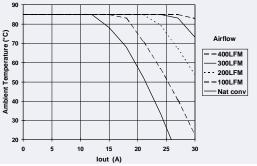


Output Ripple vs Load Current; Vin =48 V (See Note A)









Note A: All data listed in the above graphs has been developed from actual products tested at 25 °C. This data is considered typical data for the DC/DC converter. Note B: SOA curves represent operating conditions at which internal components are at or below manufacturer's maximum rated operating temperature.



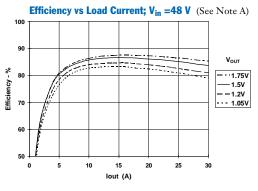
			PT4412				
Characteristic	Symbol	Conditions	Min	Typ Max		Units	
Output Current	Io	Over V _{in} range	0	-	30	А	
Input Voltage Range	Vin	Over Io Range	36	48	75	V	
Set Point Voltage Tolerance	Votol			±0.6 (1)	_	%Vo	
Temperature Variation	Reg _{temp}	$-40^{\circ} > T_a > +85 \text{ °C}$		±0.8	_	%Vo	
Line Regulation	Regline	Over V _{in} range		±1	_	mV	
Load Regulation	Regload	Over I _o range		±1	_	mV	
Total Output Voltage Variation	ΔV_{o} tot	Includes set-point, line, load, -40° >T _a > +85 °C	_	±1.6	±3	%Vo	
Efficiency	η	I ₀ =15 A		86.5	_	%	
Vo Ripple (pk-pk)	Vr	20 MHz bandwidth		30	_	mV _{pp}	
Transient Response	t _{tr}	1 A/µs load step, 50 % to 75 % Iomax	_	75	_	μs	
	ΔV_{tr}	V _o over/undershoot	_	±5	_	$%V_{o}$	
Over-Current Threshold	I _{TRIP}	Shutdown, followed by auto-recovery		38	_	А	
Output Over-Voltage Protection	OVP	Output shutdown and latch off	_	125	_	%Vo	
Switching Frequency	f_{0}	Over Vin range	225	275	325	kHz	
Under-Voltage Lockout	UVLO		_	32	_	V	
Remote On/Off Input Input High Voltage Input Low Voltage	V _{IIH} V _{IL}	Referenced to -V _{in}	4.5 -0.2	=	Open (2) +0.8	V	
Input Low Current	I_{IL}		_	-0.3	—	mA	
Standby Input Current	I _{in} standby	pins 1 & 2 connected	—	2	—	mA	
Internal Input Capacitance	Cin			1.4	_	μF	
External Output Capacitance	Cout	Between + V_o and - V_o	0		5,000	μF	
Isolation Voltage Capacitance Resistance		Input-output & input-case Input-output Input-output	$\frac{1500}{10}$	1200		Vdc pF MΩ	

PT4412 Specifications (Unless otherwise stated, $T_a = 25$ °C, $V_{in} = 48$ V, $V_o = 1.5$ V, $C_o = 0$ µF, and $I_o = I_o max$)

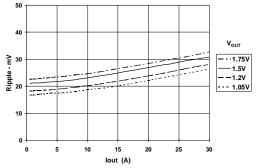
Notes: (1) If (-)Remote Sense is not used, pin 12 must be connected to pin 13 for optimum output voltage accuracy.

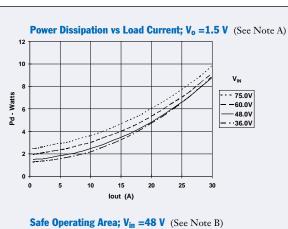
(2) The Remote On/Off input has an internal pull-up. If it is left open-circuit the module will operate when input power is applied. A discrete MOSFET or bipolar transistor is recommended to control this input. The open-circuit voltage is typically 5 V. See application notes for interface considerations.

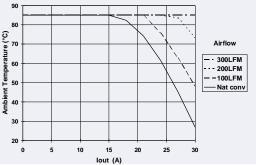
PT4412 Characterstic Data



Output Ripple vs Load Current; Vin =48 V (See Note A)







Note A: All data listed in the above graphs has been developed from actual products tested at 25 °C. This data is considered typical data for the DC-DC Converter. Note B: SOA curves represent operating conditions at which internal components are at or below manufacturer's maximum rated operating temperature.

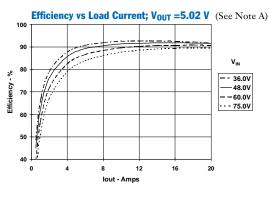
				PT4413		Units	
Characteristic	Symbol	Conditions	Min	Тур	Max		
Output Current	Io	Over V _{in} range	0	-	20	А	
Input Voltage Range	Vin	Over Io Range	36	48	75	V	
Set Point Voltage Tolerance	Votol		_	±0.6 (1)	_	%Vo	
Temperature Variation	Reg _{temp}	$-40^{\circ} > T_a > +85 \text{ °C}$	_	±0.8	_	%Vo	
Line Regulation	Regline	Over Vin range	_	±2	—	mV	
Load Regulation	Regload	Over Io range		±1	_	mV	
Total Output Voltage Variation	ΔV_{o} tot	Includes set-point, line, load, -40° >T _a > +85 °C	—	±1.6	±3	%Vo	
Efficiency	η	I _o =15 A	_	92	_	%	
Vo Ripple (pk-pk)	Vr	20MHz bandwidth	_	70	_	mV_{pp}	
Transient Response	t _{tr}	1 A/µs load step, 50 % to 100 % Iomax		75	_	μs	
	ΔV_{tr}	V _o over/undershoot		±2	_	%Vo	
Over-Current Threshold	I _{TRIP}	Shutdown, followed by auto-recovery		28	_	А	
Output Over-Voltage Protection	OVP	Output shutdown and latch off		125	_	%Vo	
Switching Frequency	$f_{ m o}$	Over Vin range	250	300	350	kHz	
Under-Voltage Lockout	UVLO		_	32	_	V	
Remote On/Off Input Input High Voltage Input Low Voltage	V _{IIH} V _{IL}	Referenced to -V _{in}	4.5 0.2	_	Open (2) +0.8	V	
Input Low Current	I_{IL}		_	-0.3	—	mA	
Standby Input Current	I _{in} standby	pins 1 & 2 connected		2	—	mA	
Internal Input Capacitance	Cin		_	1.4	_	μF	
External Output Capacitance	Cout	Between +Vo and -Vo	0		5,000	μF	
Isolation Voltage Capacitance Resistance		Input-output & input-case Input-output Input-output	$\frac{1500}{10}$	1200		Vdc pF MΩ	

PT4413 Specifications (Unless otherwise stated, $T_a = 25$ °C, $V_{in} = 48$ V, $V_o = 5.02$ V, $C_o = 0$ µF, and $I_o = I_o max$)

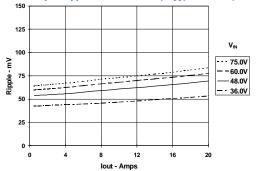
Notes: (1) If (-)Remote Sense is not used, pin 12 must be connected to pin 13 for optimum output voltage accuracy.

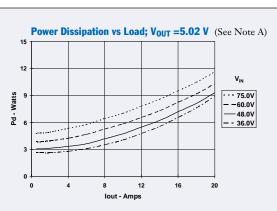
(2) The Remote On/Off input has an internal pull-up. If it is left open-circuit the module will operate when input power is applied. A discrete MOSFET or bipolar transistor is recommended to control this input. The open-circuit voltage is typically 5 V. See application notes for interface considerations.

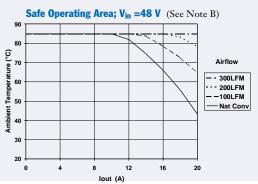
PT4413 Characterstic Data



Output Ripple vs Load Current; Vout =5.02 V (See Note A)







Note A: All data listed in the above graphs has been developed from actual products tested at 25 °C. This data is considered typical data for the DC/DC converter. Note B: SOA curves represent operating conditions at which internal components are at or below manufacturer's maximum rated operating temperature.



Operating Features and System Considerations for the PT4400/PT4410 Series of DC/DC Converters

Over-Current Protection

To protect against load faults these converters incorporate output over-current protection. Applying a load to the output that exceeds the converter's over-current threshold (see applicable specification) will cause the output voltage to momentarily fold back, and then shut down. Following shutdown the module will periodically attempt to automatically recover by initiating a soft-start power-up. This is often described as a "hiccup" mode of operation, whereby the module continues in the cycle of successive shutdown and power up until the load fault is removed. Once the fault is removed, the converter automatically recovers and returns to normal operation.

Output Over-Voltage Protection

Each converter incorporates protection circuitry that continually senses for an output overvoltage (OV) condition. The O V threshold automatically tracks the VID output voltage program setting to a level that is 25 % higher than that programmed at the control pins, VID0 through VID4. If the converter output voltage exceeds this threshold, the converter is immediately shut down and remains in a latched-off state. To resume normal operation the converter must be actively reset. This can only be done by momentarily removing the input power to the converter. For failsafe operation and redundancy, the O V protection uses circuitry that is independent of the converter's internal feedback loop.

Over-Temperature Protection

Over-temperature protection is provided by an internal temperature sensor, which closely monitors the temperature of the converter's metal case. If the case temperature exceeds a nominal 115 °C, the converter will shut down. The converter will then automatically restart when the sensed temperature drops back to approximately 105 °C. When operated outside its recommended thermal derating envelope (see data sheet SOA curves), the converter will typcially cycle on and off at intervals from a few seconds to one or two minutes. This is to ensure that the internal components are not permanently damaged from excessive thermal stress.

Under-Voltage Lockout

The Under-Voltage Lock-Out (UVLO) is designed to prevent the operation of the converter until the input voltage is close to the minimum input voltage. The converter is held off when the input voltage is below the UVLO threshold, and turns on when the input voltage rises above the threshold. This prevents high start-up current during normal power-up of the converter, and minimizes the current drain from the input source during low input voltage conditions. The converter will meet full specifications when the minimum specified input voltage is reached. The UVLO circuitry also overrides the operation of the *Remote On/Off* control. Only when the input voltage is above the UVLO threshold will the *Remote On/Off* control be functional.

Primary-Secondary Isolation

These converters incorporate electrical isolation between the input terminals (primary) and the output terminals (secondary). All converters are production tested to a withstand voltage of 1500VDC. This specification complies with UL60950 and EN60950 and the requirements for operational isolation. This allows the converter to be configured for either a positive or negative input voltage source. The data sheet 'Pin Descriptions' section provides guidance as to the correct reference that must be used for the external control signals.

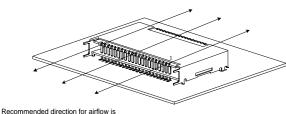
Input Current Limiting

The converter is not internally fused. For safety and overall system protection, the maximum input current to the converter must be limited. Active or passive current limiting can be used. Passive current limiting can be a fast acting fuse. A 125-V fuse, rated no more than 10 A, is recommended. Active current limiting can be implemented with a current limited "Hot-Swap" controller.

Thermal Considerations

Airflow may be necessary to ensure that the module can supply the desired load current in environments with elevated ambient temperatures. The required airflow rate may be determined from the Safe Operating Area (SOA) thermal derating chart (see converter specifications). The recommended direction for airflow is into, or perpendicular to, the longest side of the module's metal case. See Figure 1.





into (perpendicular to) the longest side



Using the Remote On/Off Function on the PT4400/PT4410 Series of DC/DC Converters

For applications requiring output voltage On/Off control, these converters incorporate a "*Remote On/Off*" control (pin 1). This feature can be used to switch the module off without removing the applied input source voltage.

The converter functions normally with Pin 1 open-circuit, providing a regulated output voltage when a valid source voltage is applied to $+V_{in}$ (pins 4, 5), with respect to $-V_{in}$ (pins 2, 3). When a low-level 1 ground signal is applied to pin 1, the converter output will be turned off.

Figure 1 is an application schematic, which shows the typical use of the *Remote On/Off* function. Note the discrete transistor (Q₁). The Remote On/Off pin has its own internal pull-up, allowing it to be controlled with an open-collector or open-drain device (See notes 2 & 3). Table 1 gives the threshold requirements.

When placed in the "Off" state, the standby current drawn from the input source is typically reduced to less than 1mA.

Table 1; Pin 1 Remote On/Off Control Requirements ¹

Parameter	Min	Тур	Max
Enable (VIH)	4.5 V	_	_
Disable (VIL)	_	_	$0.8\mathrm{V}$
Vo/c [Open-Circuit]		$5.0\mathrm{V}$	
Iin [pin 1 at –Vin]	_	_	–0.5 mA

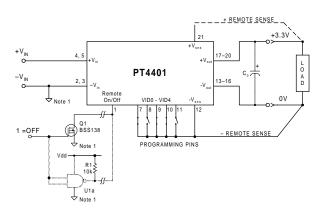
Notes:

- 1. The *Remote On/Off* control uses -V_{in} (pins 2, 3) as its ground reference. All voltages are with respect to -V_{in}.
- 2. Use an open-collector device (preferably a discrete transistor) for the *Remote On/Off* input. A pull-up resistor is not necessary. To disable the output voltage, the control pin should be pulled low to less than +0.8 V.
- 3. The *Remote On/Off* pin may be controlled with devices that have a totem-pole output. This is provided the output high-level voltage (V_{OH}) meets the module's minimum V_{IH} specified in Table 1. <u>Do not</u> apply more than +20 V. If a TTL gate is used, a pull-up resistor may be required to the logic supply voltage.
- 4. The converter incorporates an "Under-Voltage Lockout" (UVLO). The UVLO keeps the converter off until the input voltage is close to the minimum specified operating voltage. This is regardless of the state of the *Remote On/Off* control. Table 2 gives the UVLO input voltage thresholds.

Table 2; UVLO Thresholds ⁴

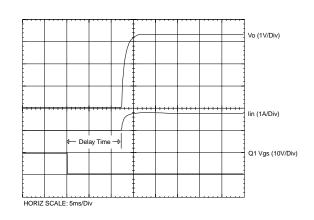
Series	V _{in} Range	UVLO Threshold	
PT4400/4410	$36-75~\mathrm{V}$	32V ±2 V	

Figure 1



Turn-On Time: In the circuit of Figure 1, turning Q_1 on applies a low-voltage to pin 1 and disables the converter output. Correspondingly, turning Q_1 off allows pin 1 to be pulled high by an internal pull-up resistor. The converter produces a regulated output voltage within 50ms. Figure 2 shows the output response of a PT4401 following the turn-off of Q_1 . The turn off of Q_1 corresponds to the drop in Q_1 Vgs. Although the rise-time of the output voltage is short (<5 ms), the indicated delay time will vary depending upon the input voltage of the PT4401 was set to 3.3 V by connecting VID0 (pin 7), VID2 (pin 9), and VID3 (pin 10) to the (–)Remote Sense (pin 12). The waveforms were measured with 48 VDC input voltage, and a 10 A resistive load.





Pin-Coded Output Voltage Adjustment on the PT4400/4410 Series of DC/DC Converters

These DC/DC converters have a programmable output voltage. In each case the desired output voltage must be selected from one of a number of discrete voltages using the voltage programming control pins. Depending on each model's resolution and adjustment range, there are up to five control pins. They are identified *VID0–VID4* (pins 7–11) respectively. By selectively strapping these control pins to (*–)Remote Sense* (pin 12), the output voltage can be programmed to one of up to 32 different values over the defined output voltage range. The program code and output voltage range of the PT4401/4411 is also compatible with the "Voltage ID" code defined in the Intel® VRM 8.2 specification. Refer to the applicable product specification sheet for the program code.

Notes:

- The programming convention is as follows:-Logic 0: Connect to pin 12 (–Remote Sense). Logic 1: Open circuit/open drain (See notes 2, & 4)
- 2. Do not connect pull-up resistors to the voltage programming pins.
- 3. To minimize output voltage error, always use pin 12 (-Remote Sense) as the logic "0" reference. While -Vout (pins 13-16) can also be used for programming, doing so will degrade the voltage selection accuracy and load regulation of the product.
- 4. When VID0–VID4 are all open circuit (logic 1), the output voltage is undefined. In this state the output voltage of the converter cannot be guaranteed, and can vary with output load and input voltage.
- 5. On all models other than the PT4401/4411, the contol

input VID4 (pin 11) is internally disabled and is not functional.

6. If active devices are used to ground the voltage control pins, low-level open drain MOSFET devices should be used over bipolar transistors. The inherent $V_{ce}(sat)$ in bipolar devices introduces errors in the device's internal voltage control circuit. Discrete transistors such as the BSS138 or IRLML2402 are examples of appropriate devices.

Active Voltage Programming:

Special precautions should be taken when making changes to the voltage progam code while the output is active. This activity induces a transient, which may activate the module's output over-voltage (OV) protection. Once triggered the OV protection circuit latches the output off, and requires the momentary removal of input power to reset the module. OV protection trips can be avoided by limiting the output voltage adjustment to no more than a 15 % change from the initial voltage. Large transitions are best made with a series of incremental changes, allowing 100 µs settling time between each program state. When using active devices to program the output voltage, their state should be asserted prior to input power being applied. An alternative is to pull pin 1 (Remote On/Off) to $-V_{in}$ (pins 2, 3) during the application of power, assert the required program code, and then release pin 1. The module will than initiate a soft-start power-up to the desired program voltage.

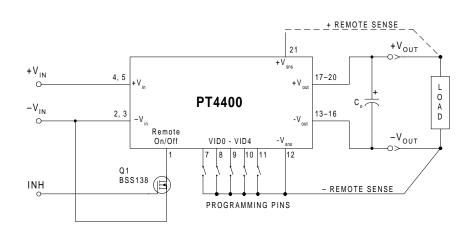


Figure 1



PCB Dual Layout for PT4400/4410 and ¹/₄-Brick Package Alternate Build Option

The PCB footprint for the horizontal package versions (suffixes A & C) of the PT4400 and PT4410 series are dimensionally similar to a standard quarter-brick outline, making it easy to accommodate either package on the host PCB. This can provide the option for a second source, or in the case of the PT4400/4410 product, the added functionality of VID output voltage selection in a surface mount compatible package.

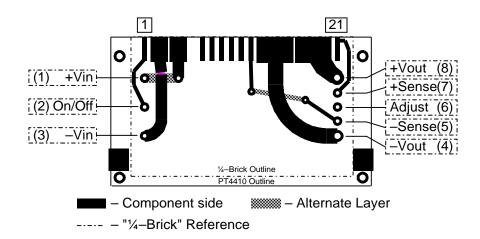
Figure 4-1 shows an example of an alternate PCB layout that will accommodate the surface mount version of the PT product (package code ENP). It should be noted that Figure 4-1 is a dimensionless drawing and is offered only as a guide. Please refer to the respective package outline drawing and PCB layout recommendations for the products actually employed. As as an additional reference, Table 4-1 provides the pin-out for the PT4400/4410 series product.

Table 4-1; PT4400/4410 Pin-Out Reference

PT4400/4410

Pin	Function
1	Remote On/Off
2	-V _{in}
3	-V _{in}
4	+Vin
5	+Vin
6	Pin Not Present
7	VID 0
8	VID 1
9	VID 2
10	VID 3
11	VID 4
12	Sense (-)
13	-V _{out}
14	-V _{out}
15	-V _{out}
16	-V _{out}
17	+V _{out}
18	+V _{out}
19	+V _{out}
20	+V _{out}
21	Sense (+)

Figure 4-1; Example PCB Layout for PT4400/4410 and ¼-Brick Package Alternate Build



V Texas Instruments



2-Feb-2014

PACKAGING INFORMATION

Orderable Device	Status	Package Type	Package	Pins	Package	Eco Plan	Lead/Ball Finish	MSL Peak Temp	Op Temp (°C)	Device Marking	Samples
	(1)		Drawing		Qty	(2)	(6)	(3)		(4/5)	
PT4413C	OBSOLETE	SIP MODULE	ENP	21		TBD	Call TI	Call TI	-40 to 85		

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

⁽³⁾ MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

⁽⁴⁾ There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

⁽⁶⁾ Lead/Ball Finish - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

Important Information and Disclaimer: The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

IMPORTANT NOTICE

Texas Instruments Incorporated and its subsidiaries (TI) reserve the right to make corrections, enhancements, improvements and other changes to its semiconductor products and services per JESD46, latest issue, and to discontinue any product or service per JESD48, latest issue. Buyers should obtain the latest relevant information before placing orders and should verify that such information is current and complete. All semiconductor products (also referred to herein as "components") are sold subject to TI's terms and conditions of sale supplied at the time of order acknowledgment.

TI warrants performance of its components to the specifications applicable at the time of sale, in accordance with the warranty in TI's terms and conditions of sale of semiconductor products. Testing and other quality control techniques are used to the extent TI deems necessary to support this warranty. Except where mandated by applicable law, testing of all parameters of each component is not necessarily performed.

TI assumes no liability for applications assistance or the design of Buyers' products. Buyers are responsible for their products and applications using TI components. To minimize the risks associated with Buyers' products and applications, Buyers should provide adequate design and operating safeguards.

TI does not warrant or represent that any license, either express or implied, is granted under any patent right, copyright, mask work right, or other intellectual property right relating to any combination, machine, or process in which TI components or services are used. Information published by TI regarding third-party products or services does not constitute a license to use such products or services or a warranty or endorsement thereof. Use of such information may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.

Reproduction of significant portions of TI information in TI data books or data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. TI is not responsible or liable for such altered documentation. Information of third parties may be subject to additional restrictions.

Resale of TI components or services with statements different from or beyond the parameters stated by TI for that component or service voids all express and any implied warranties for the associated TI component or service and is an unfair and deceptive business practice. TI is not responsible or liable for any such statements.

Buyer acknowledges and agrees that it is solely responsible for compliance with all legal, regulatory and safety-related requirements concerning its products, and any use of TI components in its applications, notwithstanding any applications-related information or support that may be provided by TI. Buyer represents and agrees that it has all the necessary expertise to create and implement safeguards which anticipate dangerous consequences of failures, monitor failures and their consequences, lessen the likelihood of failures that might cause harm and take appropriate remedial actions. Buyer will fully indemnify TI and its representatives against any damages arising out of the use of any TI components in safety-critical applications.

In some cases, TI components may be promoted specifically to facilitate safety-related applications. With such components, TI's goal is to help enable customers to design and create their own end-product solutions that meet applicable functional safety standards and requirements. Nonetheless, such components are subject to these terms.

No TI components are authorized for use in FDA Class III (or similar life-critical medical equipment) unless authorized officers of the parties have executed a special agreement specifically governing such use.

Only those TI components which TI has specifically designated as military grade or "enhanced plastic" are designed and intended for use in military/aerospace applications or environments. Buyer acknowledges and agrees that any military or aerospace use of TI components which have *not* been so designated is solely at the Buyer's risk, and that Buyer is solely responsible for compliance with all legal and regulatory requirements in connection with such use.

TI has specifically designated certain components as meeting ISO/TS16949 requirements, mainly for automotive use. In any case of use of non-designated products, TI will not be responsible for any failure to meet ISO/TS16949.

Products		Applications	
Audio	www.ti.com/audio	Automotive and Transportation	www.ti.com/automotive
Amplifiers	amplifier.ti.com	Communications and Telecom	www.ti.com/communications
Data Converters	dataconverter.ti.com	Computers and Peripherals	www.ti.com/computers
DLP® Products	www.dlp.com	Consumer Electronics	www.ti.com/consumer-apps
DSP	dsp.ti.com	Energy and Lighting	www.ti.com/energy
Clocks and Timers	www.ti.com/clocks	Industrial	www.ti.com/industrial
Interface	interface.ti.com	Medical	www.ti.com/medical
Logic	logic.ti.com	Security	www.ti.com/security
Power Mgmt	power.ti.com	Space, Avionics and Defense	www.ti.com/space-avionics-defense
Microcontrollers	microcontroller.ti.com	Video and Imaging	www.ti.com/video
RFID	www.ti-rfid.com		
OMAP Applications Processors	www.ti.com/omap	TI E2E Community	e2e.ti.com
Wireless Connectivity	www.ti.com/wirelessconne	ectivity	

Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265 Copyright © 2014, Texas Instruments Incorporated